

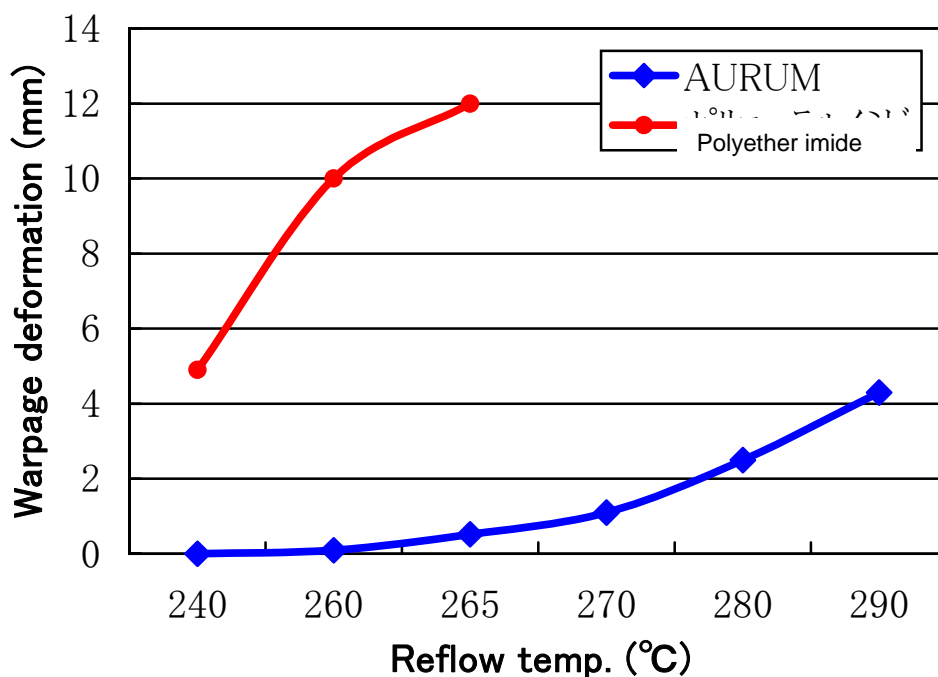
Technical Literature I-10

Soldering Reflow of AURUM®

After a sample has been exposed to each temperature for 20 seconds, the amount of warpage deformation was measured.

It is assumed that AURUM® is usable up to the soldering reflow temperature of 270°C, with the amount of warpage deformation of AURUM® remaining small up to 270°C.

Sample form: 40 x 80, t = 2 (mm)



The information contained herein is based on the information and data available at this moment, but none of the data or evaluation results contained herein provide any warranty whatsoever.